



SPECIFICATION

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SPEC. NO.: PS-50398-XXXXX-XXX

REVISION: C

PRODUCT NAME: 0.5 WTB LVDS CONN.

PRODUCT NO:

50398-XXXXX-001 / 50399-XXXXX-001
50406-XXXXX-001 / 50407-XXXXX-001
50449-XXXXX-001 / 50412-XXXXX-001

PREPARED: ALEX DATE: 2010.12.29	CHECKED: RYAN DATE: 2010.12.29	APPROVED: JASON DATE: 2010.12,29
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Aces P/N: **50398 Series**

TITLE: **0.5 WTB LVDS CONN.**

RELEASE DATE: 2010.12.29

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ECN No:1012225

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1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
1	ECN-0908092	FIRST SPEC RELEASE	JASON	2009.08.13
2	ECN-0910246	ADD 30&20 PIN SPEC	JASON	2009.10.30
O	ECN-0912012	REV-O	JASON	2009.12.10
A	ECN-1006128	MODIFY SALT SPRAY CONDITION	JASON	2010.06.14
B	ECN-1007224	MODIFY 20PIN INSERTION FORCE	ALEX	2010.08.02
C	ECN-1012225	ADD PART NUMBER 50449	ALEX	2010.12.29

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2 SCOPE

This specification covers performance, tests and quality requirements for **0.5 WTB LVDS CONN.**

Female Board P/N : **50398,50406**

Male Cable P/N : **50399,50407,50412,50449**

Cable:Fine Coaxial cable **AWG#36~42**

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

4.1 Design and Construction

- 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
- 4.1.2 All materials conform to RoHS. And the standard depends on TQ-W1-140101

4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy (**Phosphor Bronze**)
Finish: (a) Contact: **Gold Flash plated over all or 10u"**
(b) Under plate: **Nickel-plated all over**
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Upper Shell: **Copper Alloy, Nickel-plated**
- 4.2.4 Lower Shell: **Stainless steel, Nickel-plated**

4.3 Ratings

- 4.3.1 Voltage: **50 Volts AC (r.m.s)**
- 4.3.2 Current: 0.3~0.2 Amperes /pin (depending on the diameter of cable conductor)
Coaxial cables AWG#36: **0.30AAC,DC PER CONTACT**
AWG#40: **0.25AAC,DC PER CONTACT**
AWG#42: **0.20AAC,DC PER CONTACT**
- 4.3.3 Operating Temperature : **-55°C to +85°C**

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
ELECTRICAL		
Item	Requirement	Standard
Low Level Contact Resistance	60 m Ω Max.(initial) per contact 90 m Ω Max.(finish)	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	100 M Ω Min.	Unmated connectors, apply 250 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	150 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)

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MECHANICAL

Mating / Unmating Forces	See item 6	<p>Operation Speed : 25.4 ± 3 mm/minute.. Measure the force required to mate/unmate connector.</p> <p>(EIA-364-13)</p>
Durability	30 cycles.	<p>The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min.</p> <p>(EIA-364-09B)</p>
Vibration	1 μ s Max.	<p>The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions.</p> <p>(EIA-364-28 Condition I)</p>
Shock (Mechanical)	1 μ s Max.	<p>Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts.</p> <p>(EIA-364-27, test condition A)</p>

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ENVIRONMENTAL		
Item	Requirement	Standard
Temperature life	See Product Qualification and Test Sequence Group 4	Subject mated connectors to temperature life at 85°C for 96 hours . (EIA-364-17, Test condition A)
Thermal Shock	See Product Qualification and Test Sequence Group 5	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes Transform 5 minutes (EIA-364-32, test condition A)
Humidity	See Product Qualification and Test Sequence Group 5	Mated Connector 40°C, 90~95% RH, 96 hours (EIA-364-31,Condition A, Method II)
Salt Spray	See Product Qualification and Test Sequence Group of Gold	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C for 48 hours . (EIA-364-26,Test condition B)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	Subject the test area of contacts into the flux for 5-10 sec. And then into solder bath, Temperature at 245 ±5°C , for 4-5 sec. (EIA-364-52)
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 8 (Lead Free) 2 Times	Pre Heat : 150~180°C, 60~90sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max.
Hand Soldering Temperature Resistance	Appearance: No damage	T ≥ 350°C, 3sec at least.

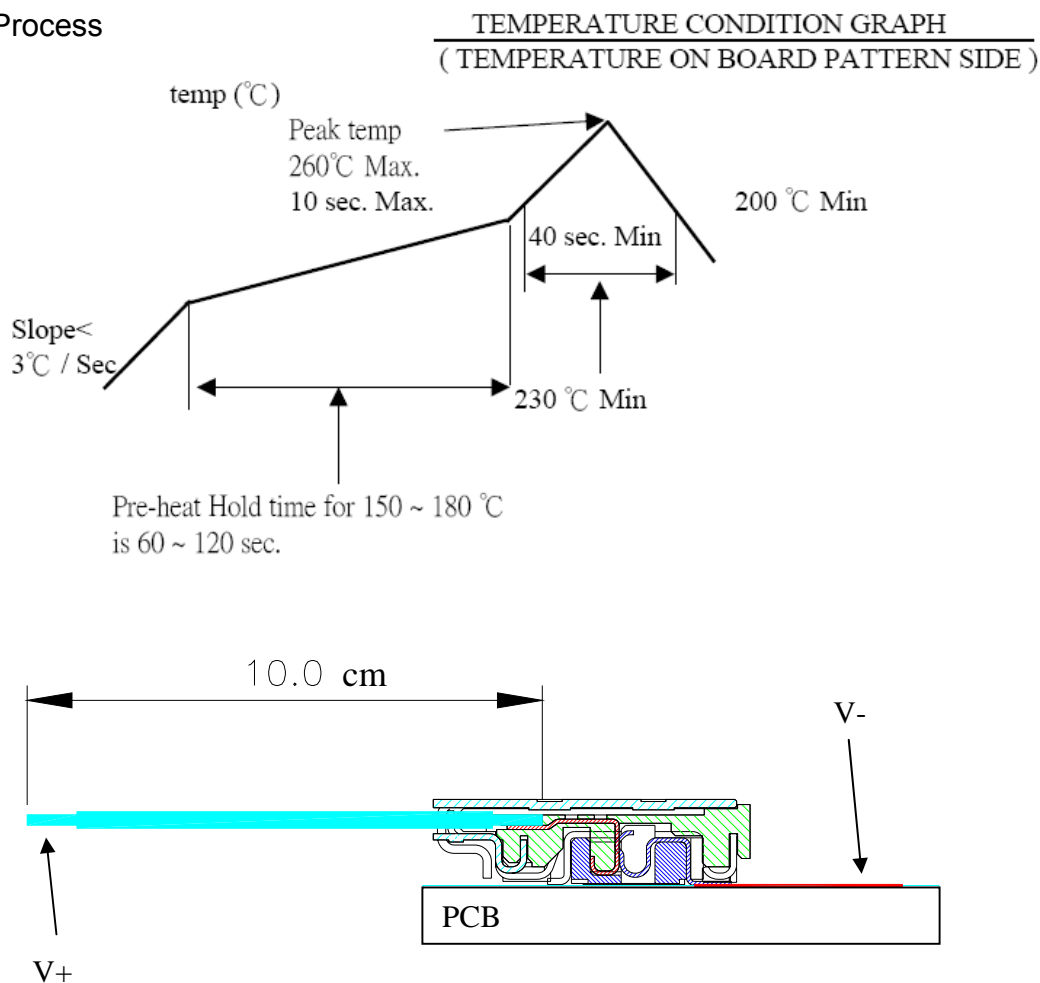
Note. Flowing Mixed Gas shell be conduct by customer request.

6 Insertion / Extraction Force

NO. OF Ckt.	Initial		After 30 th Cycle	
	Insertion Force (Max.)	Extraction Force (Min.)	Insertion Force (Max.)	Extraction Force (Min)
40	65N / 6.6Kgf	12N / 1.2kgf	40N / 4.0Kgf	6.5N / 0.65Kgf
30	50N / 5.0Kgf	10N / 1.0Kgf	35N / 3.5Kgf	5.0N / 0.50Kgf
20	40N / 4.0Kgf	6.5N / 0.65Kgf	30N / 3.0Kgf	3.5N / 0.35Kgf

7 INFRARED REFLOW CONDITION

Lead-free Process



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8.PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group									
	1	2	3	4	5	6	7	8		
	Test Sequence									
Examination of Product	1,3	1,5	1,5	1,6	1,7	1,4		1,3		
Low Level Contact Resistance		2,7	2,6	2,7	2,8	2,5				
Insulation Resistance				3,8	3,9					
Dielectric Withstanding Voltage				4,9	4,10					
Temperature rise	2									
Mating / Unmating Forces		3,6								
Durability		4								
Vibration			3							
Shock (Mechanical)			4							
Temperature life				5						
Thermal Shock					5					
Humidity					6					
Salt Spray						3				
Solder ability							1			
Resistance to Soldering Heat								2		
Number of Sample	2	4	4	4	4	4	2	4		